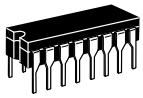
12-Bit Parity Generator-Checker

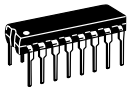
MC10160

The MC10160 consists of nine Exclusive-OR gates in a single package, internally connected to provide odd parity checking or generation. Output goes high when an odd number of inputs are high. Unconnected inputs are pulled to low logic levels allowing parity detection and generation for less than 12 bits.

P_D = 320 mW typ/pkg (No Load)
t_{pd} = 5.0 ns typ
t_r, t_f = 2.0 ns typ (20%–80%)

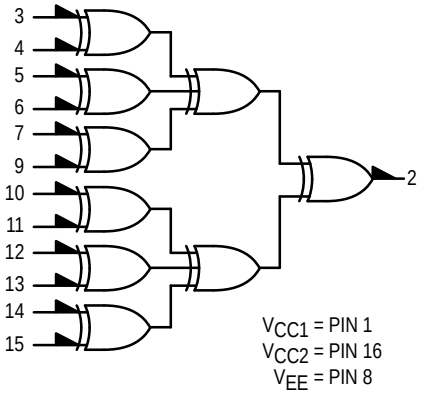


L SUFFIX
CERAMIC PACKAGE
CASE 620–10

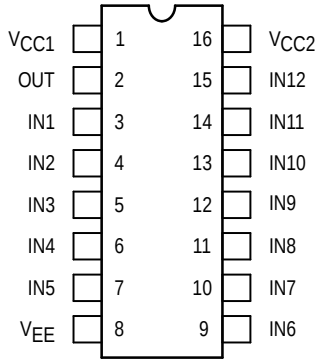


P SUFFIX
PLASTIC PACKAGE
CASE 648–08

LOGIC DIAGRAM



PIN ASSIGNMENT



INPUT	OUTPUT
Sum of High Level Inputs	Pin 2
Even	Low
Odd	High

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			–30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I_E	8		86		62	78		86	mAdc
Input Current	I_{inH} (Note 1.)	3 4		425 350			265 220		265 220	µAdc
	I_{inL}	3	0.5		0.5			0.3		µAdc
Output Voltage Logic 1	V_{OH}	2	–1.060	–0.890	–0.960		–0.810	–0.890	–0.700	Vdc
Output Voltage Logic 0	V_{OL}	2	–1.890	–1.675	–1.850		–1.650	–1.825	–1.615	Vdc
Threshold Voltage Logic 1	V_{OHA}	2	–1.080		–0.980			–0.910		Vdc
Threshold Voltage Logic 0	V_{OLA}	2		–1.655			–1.630		–1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t_{3+2+}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
	$t_{3+2–}$	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
	$t_{3–2–}$	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
	$t_{3–2+}$	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
	t_{4+2+}	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
	$t_{4+2–}$	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
	$t_{4–2–}$	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
	$t_{4–2+}$	2	1.8	8.1	2.0	5.0	7.5	2.0	8.0	
Rise Time (20 to 80%)	t_{2+}	2	1.1	3.5	1.1	2.0	3.3	1.0	3.5	
Fall Time (20 to 80%)	$t_{2–}$	2	1.1	3.5	1.1	2.0	3.3	1.0	3.5	

1. Pins 3, 6, 7, 11, 12, 15 are similar. Pins 4, 5, 9, 10, 13, 14 are similar.

ELECTRICAL CHARACTERISTICS (continued)

@ Test Temperature	TEST VOLTAGE VALUES (Volts) V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}
–30°C	–0.890	–1.890	–1.205	–1.500	–5.2
+25°C	–0.810	–1.850	–1.105	–1.475	–5.2
+85°C	–0.700	–1.825	–1.035	–1.440	–5.2

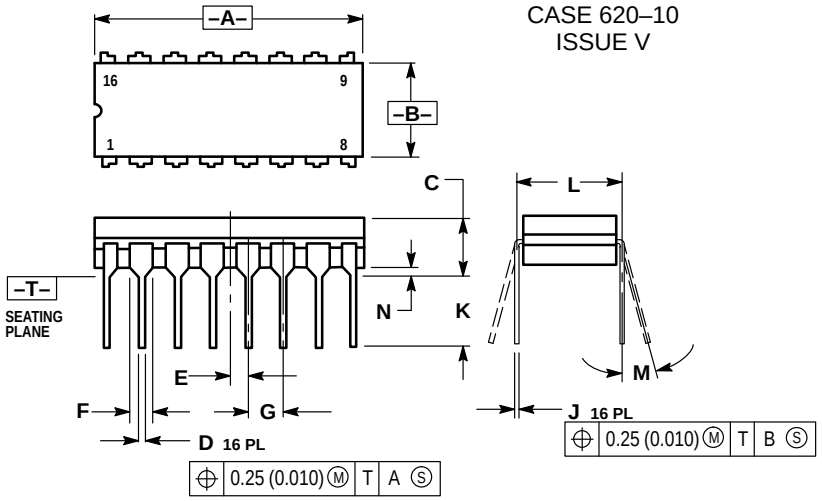
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW V_{IHmax}	V_{ILmin}	V_{IHAmin}	V_{ILAmax}	V_{EE}	(V_{CC}) Gnd
Power Supply Drain Current	I_E	8	4,5,9, 10,13,14				8	1,16
Input Current	I_{inH} (Note 1.)	3 4	3 4				8 8	1,16 1,16
	I_{inL}	3		3			8	1,16
Output Voltage Logic 1	V_{OH}	2	3	4,5,6,7,9,10, 11,12,13,14,15			8	1,16
Output Voltage Logic 0	V_{OL}	2		3,4,5,6,7,9,10, 11,12,13,14,15			8	1,16
Threshold Voltage Logic 1	V_{OHA}	2		4,5,6,7,9,10, 11,12,13,14,15	3		8	1,16
Threshold Voltage Logic 0	V_{OLA}	2		3,5,6,7,9,10, 11,12,13,14,15		4	8	1,16
Switching Times (50Ω Load)			**+1.11V**		**Pulse In**	**Pulse Out**	**–3.2 V**	**+2.0 V**
Propagation Delay	t_{3+2+}	2			3	2	8	1,16
	$t_{3+2–}$	2	4		3	2	8	1,16
	$t_{3–2–}$	2			3	2	8	1,16
	$t_{3–2+}$	2	4		3	2	8	1,16
	t_{4+2+}	2			4	2	8	1,16
	$t_{4+2–}$	2	3		4	2	8	1,16
	$t_{4–2–}$	2			4	2	8	1,16
	$t_{4–2+}$	2	3		4	2	8	1,16
Rise Time (20 to 80%)	t_{2+}	2			3	2	8	1,16
Fall Time (20 to 80%)	$t_{2–}$	2			3	2	8	1,16

1. Pins 3, 6, 7, 11, 12, 15 are similar. Pins 4, 5, 9, 10, 13, 14 are similar.

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50–ohm resistor to –2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

OUTLINE DIMENSIONS

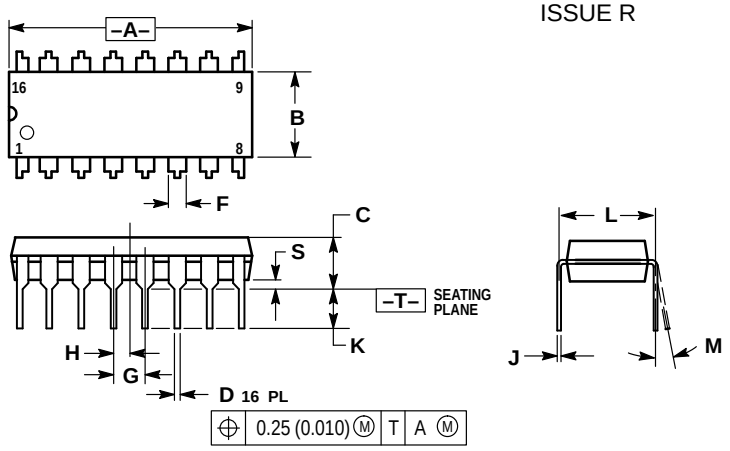
L SUFFIX
CERAMIC DIP PACKAGE
CASE 620–10
ISSUE V



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0 °	15 °	0 °	15 °
N	0.020	0.040	0.51	1.01

P SUFFIX
PLASTIC DIP PACKAGE
CASE 648–08
ISSUE R



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0 °	10 °	0 °	10 °
S	0.020	0.040	0.51	1.01

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